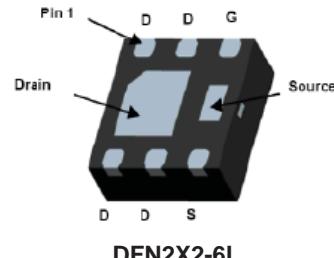


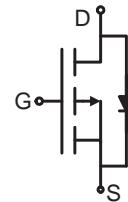
Features

- $V_{DS} = -12V, I_D = -16A$
- $R_{DS(ON)} < 22m\Omega @ V_{GS}=-2.5V$
- $R_{DS(ON)} < 18m\Omega @ V_{GS}=-4.5V$
- Advanced trench MOSFET process technology
- Ultra low on-resistance with low gate charge

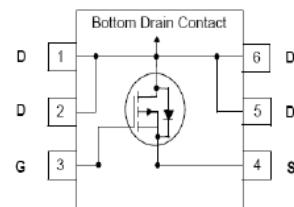


Application

- PWM applications
- Load switch
- Battery charge in cellular handset



Schematic diagram



Absolute maximum ratings ($T_C=25^\circ C$ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V_{DS}	-12	V
Gate-Source Voltage	V_{GS}	± 12	V
Drain Current-Continuous	I_D	-16	A
Drain Current -Pulsed (Note 1)	I_{DM}	-65	A
Maximum Power Dissipation	P_D	18	W
Operating Junction and Storage Temperature Range	T_J, T_{STG}	-55 To 150	$^\circ C$

Thermal Characteristic

Thermal Resistance,Junction-to-Case (Note 2)	$R_{\theta JC}$	6.9	$^\circ C/W$
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Electrical characteristics ($T_A=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{GS}=0\text{V}, I_D=-250\mu\text{A}$	-12	-	-	V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=-12\text{V}, V_{GS}=0\text{V}$	-	-	-1	μA
Gate-Body Leakage Current	I_{GSS}	$V_{GS}=\pm12\text{V}, V_{DS}=0\text{V}$	-	-	±100	nA
On Characteristics ^(Note 3)						
Gate Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS}=V_{GS}, I_D=-250\mu\text{A}$	-0.4	-0.7	-1	V
Drain-Source On-State Resistance	$R_{DS(\text{ON})}$	$V_{GS}=-4.5\text{V}, I_D=-6.7\text{A}$	-	11.5	18	$\text{m}\Omega$
		$V_{GS}=-2.5\text{V}, I_D=-6.2\text{A}$	-	14	22	$\text{m}\Omega$
Forward Transconductance	g_{FS}	$V_{DS}=-5\text{V}, I_D=-6.7\text{A}$	20	-	-	S
Dynamic Characteristics ^(Note 4)						
Input Capacitance	C_{iss}	$V_{DS}=-10\text{V}, V_{GS}=0\text{V}, F=1.0\text{MHz}$	-	2700	-	PF
Output Capacitance	C_{oss}		-	680	-	PF
Reverse Transfer Capacitance	C_{rss}		-	590	-	PF
Switching Characteristics ^(Note 4)						
Turn-on Delay Time	$t_{d(on)}$	$V_{DD}=-10\text{V}, I_D=-1\text{A}$ $V_{GS}=-4.5\text{V}, R_{GEN}=10\Omega$	-	11	-	nS
Turn-on Rise Time	t_r		-	35	-	nS
Turn-Off Delay Time	$t_{d(off)}$		-	30	-	nS
Turn-Off Fall Time	t_f		-	10	-	nS
Total Gate Charge	Q_g	$V_{DS}=-6\text{V}, I_D=-10\text{A}, V_{GS}=-4.5\text{V}$	-	35	48	nC
Gate-Source Charge	Q_{gs}		-	5	-	nC
Gate-Drain Charge	Q_{gd}		-	10	-	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage ^(Note 3)	V_{SD}	$V_{GS}=0\text{V}, I_S=-8\text{A}$	-	-	-1.2	V
Diode Forward Current ^(Note 2)	I_S		-	-	-16	A

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board, $t \leq 10$ sec.
3. Pulse Test: Pulse Width $\leq 300\mu\text{s}$, Duty Cycle $\leq 2\%$.
4. Guaranteed by design, not subject to production

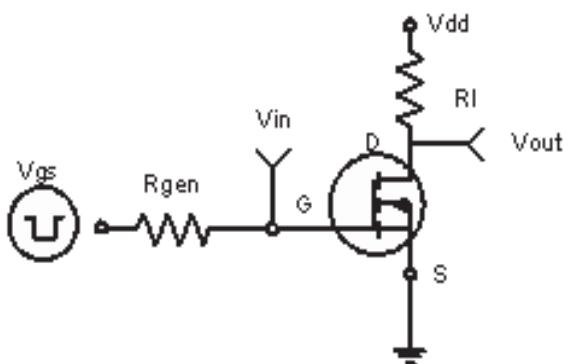


Figure 1:Switching Test Circuit

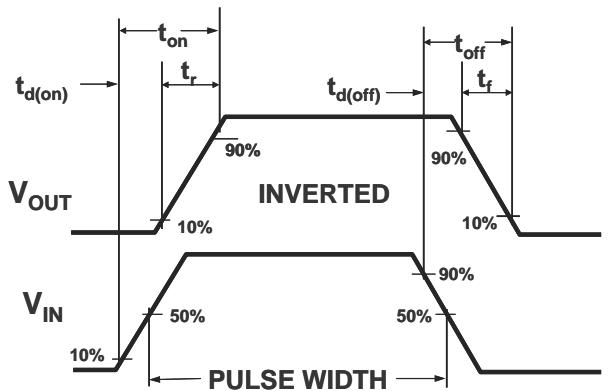


Figure 2:Switching Waveforms

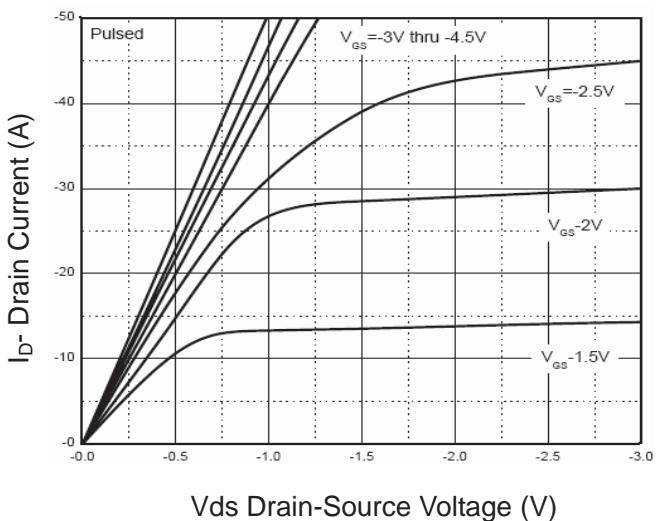


Figure 3 Output Characteristics

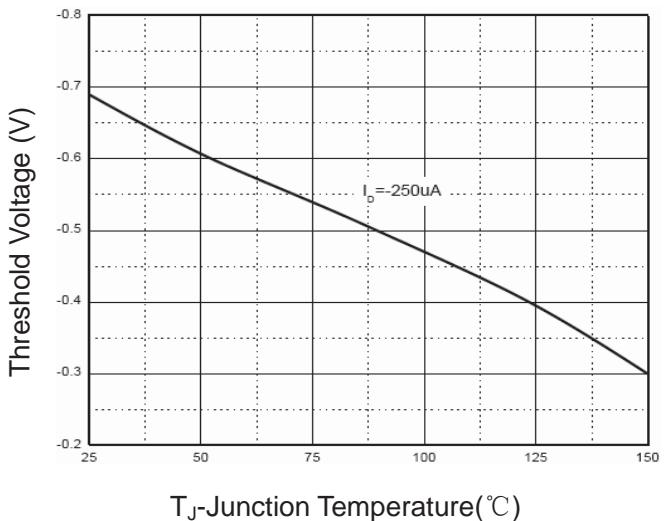
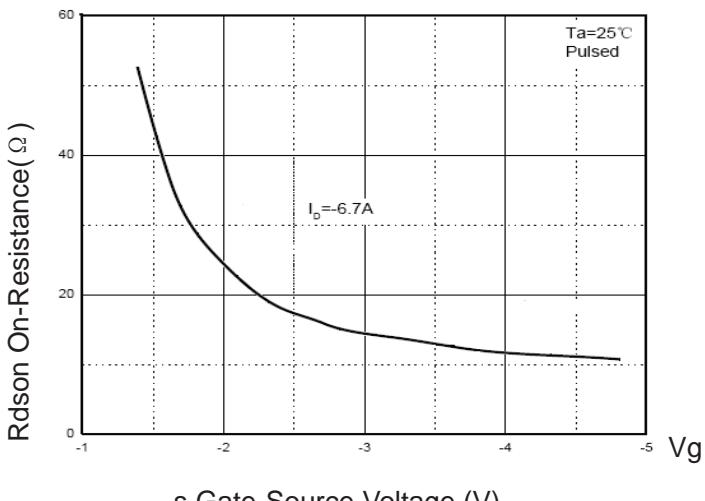
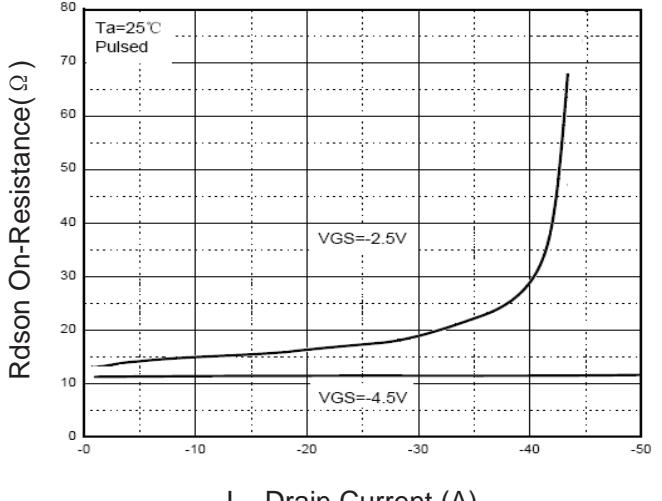


Figure 4 Drain Current



s Gate-Source Voltage (V)

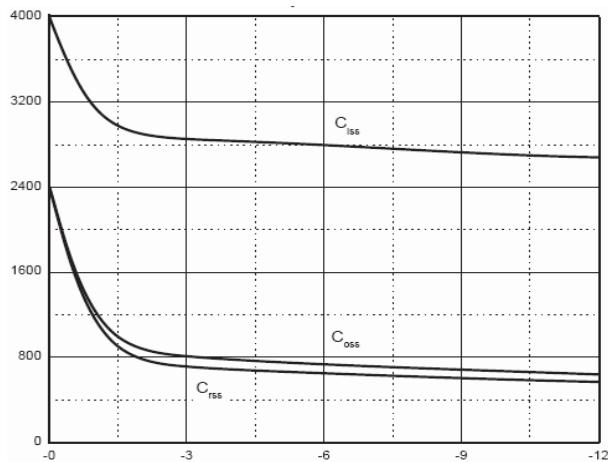
Figure 5 Rdson vs Vgs



I_D- Drain Current (A)

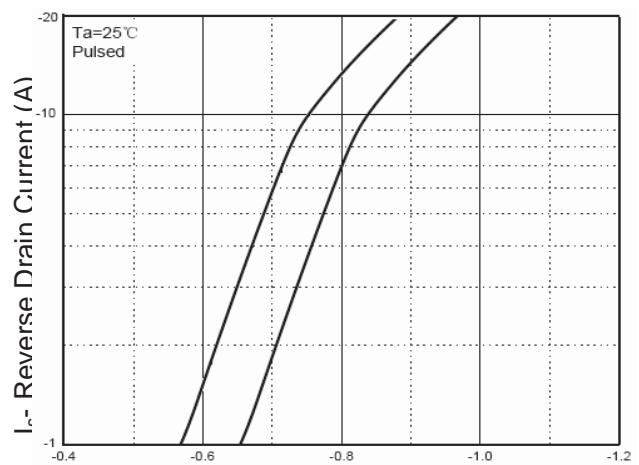
Figure 6 Drain-Source On-Resistance

C Capacitance (pF)



Vds Drain-Source Voltage (V)

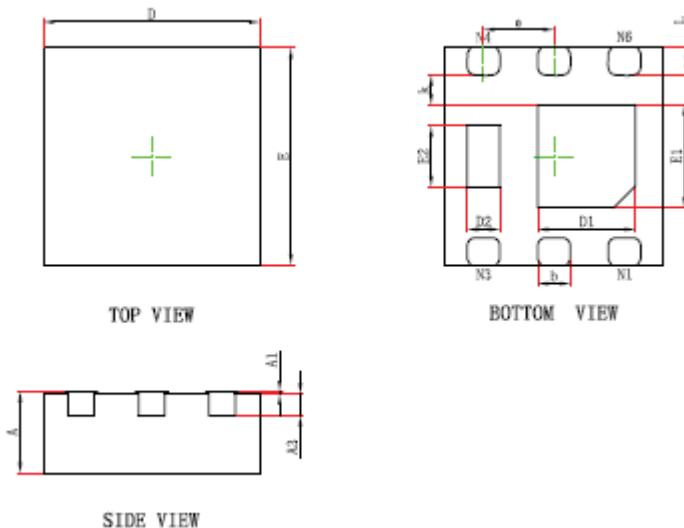
Figure 7 Capacitance vs Vds



Vsd Source-Drain Voltage (V)

Figure 8 Source- Drain Diode Forward

DFN2X2-6L Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.700	0.800	0.028	0.031
A1	0.000	0.050	0.000	0.002
A3	0.203REF.		0.008REF.	
D	1.924	2.076	0.076	0.082
E	1.924	2.076	0.076	0.082
D1	0.800	1.000	0.031	0.039
E1	0.850	1.050	0.033	0.041
D2	0.200	0.400	0.008	0.016
E2	0.460	0.660	0.018	0.026
k	0.200MIN.		0.008MIN.	
b	0.250	0.350	0.010	0.014
e	0.650TYP.		0.026TYP.	
L	0.174	0.326	0.007	0.013

Notes

1. All dimensions are in millimeters.
2. Tolerance $\pm 0.10\text{mm}$ (4 mil) unless otherwise specified
3. Package body sizes exclude mold flash and gate burrs. Mold flash at the non-lead sides should be less than 5 mils.
4. Dimension L is measured in gauge plane.
5. Controlling dimension is millimeter, converted inch dimensions are not necessarily exact.